

March 1997 Revised March 1999

74VHCT245A Octal Buffer/Line Driver with 3-STATE Outputs

General Description

The VHCT245A is an advanced high speed CMOS octal bus transceiver fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. The VHCT245A is intended for bidirectional asynchronous communication between data busses. The direction of data transmission is determined by the level of the T/R input. The enable input can be used to disable the device so that the busses are effectively isolated. Protection circuits ensure that 0V to 7V can be applied to

Protection circuits ensure that 0V to 7V can be applied to the input and output (Note 1) pins without regard to the supply voltage. These circuits prevent device destruction due to mismatched supply and input/output voltages. This device can be used to interface 5V to 3V systems and two supply systems such as battery back up.

Note 1: Outputs in OFF-State

Features

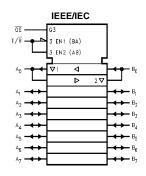
- High Speed: $t_{PD} = 5.4 \text{ ns (typ)}$ at $V_{CC} = 5V$
- Power Down Protection on Inputs and Outputs
- \blacksquare Low Power Dissipation: $~I_{CC}=4~\mu\text{A}$ (Max) @ $T_{A}=25^{\circ}\text{C}$
- Pin and Function Compatible with 74HCT245

Ordering Code:

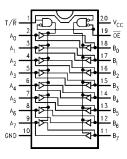
Order Number	Package Number	Package Description
74VHCT245AM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74VHCT245ASJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHCT245AMTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74VHCT245AN	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagram



Pin Descriptions

Pin Names	Description				
ŌE	Output Enable Input				
T/R	Transmit/Receive Input				
A ₀ -A ₇	Side A Inputs or 3-STATE Outputs				
B ₀ -B ₇	Side B Inputs or 3-STATE Outputs				

Truth Table

Inp	uts	Quitnuto					
OE	T/R	Outputs					
L	L	Bus B Data to Bus A					
L	Н	Bus A Data to Bus B					
Н	Х	HIGH-Z State					

H = HIGH Voltage Level L = LOW Voltage Level

Absolute Maximum Ratings(Note 2)

 $\begin{array}{ll} \mbox{(Note 4)} & -0.5\mbox{V to } +7.0\mbox{V} \\ \mbox{Input Diode Current (I_{IK})} & -20\mbox{ mA} \\ \mbox{Output Diode Current (I_{OK}) (Note 5)} & \pm 20\mbox{ mA} \\ \end{array}$

DC Output Current (I_{OUT}) ± 25 mA DC V_{CC}/GND Current (I_{CC}) ± 75 mA Storage Temperature (T_{STG}) -65° C to $+150^{\circ}$ C

Lead Temperature (T_L)

(Soldering, 10 seconds) 260°C

Recommended Operating Conditions (Note 6)

 $\begin{array}{ll} \mbox{Supply Voltage (V}_{\mbox{CC}}) & 4.5\mbox{V to } +5.5\mbox{V} \\ \mbox{Input Voltage (V}_{\mbox{IN}}) & 0\mbox{V to } +5.5\mbox{V} \end{array}$

Output Voltage (V_{OUT})

(Note 3) 0V to V_{CC} (Note 4) 0V to +5.5V Operating Temperature (T_{OPR}) -40°C to +85 $^{\circ}\text{C}$

Input Rise and Fall Time (t_r, t_f)

 $V_{CC} = 5.0 V \pm 0.5 V$ 0 ns/V ~ 20 ns/V

Note 2: Absolute Maximum Ratings are values beyond which the device may be damaged or have its useful life impaired. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside databook specifications

Note 3: HIGH or LOW state. I_{OUT} absolute maximum rating must be observed.

Note 4: When outputs are in OFF-State or when $V_{CC} = OV$.

Note 5: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$ (Outputs Active).

Note 6: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	T _A = 25°C			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
			Min	Тур	Max	Min	Max	Units	Conditions	
V _{IH}	HIGH Level	4.5	2.0			2.0		V		
	Input Voltage	5.5	2.0			2.0		V		
V _{IL}	LOW Level	4.5			0.8		0.8	V		
	Input Voltage	5.5			0.8		0.8	V		
V _{OH}	HIGH Level	4.5	4.40	4.50		4.40		V	$V_{IN} = V_{IH}$ $I_{OH} = -50 \mu A$	
	Output Voltage	4.5	3.94			3.80		V	or V_{IL} $I_{OH} = -8 \text{ mA}$	
V _{OL}	LOW Level	4.5		0.0	0.1		0.1	V	$V_{IN} = V_{IH}$ $I_{OL} = 50 \mu A$	
	Output Voltage	4.5			0.36		0.44	V	or V_{IL} $I_{OL} = 8 \text{ mA}$	
I _{OZ}	3-STATE Output	5.5			±0.25		±2.5	μА	V _{IN} = V _{IH} or V _{IL}	
	Off-State Current	5.5			±0.25	±2.5	μΑ	$V_{OUT} = V_{CC}$ or GND		
I _{IN}	Input Leakage	0-5.5			±0.1		±1.0	μА	V _{IN} = 5.5V or GND	
	Current	0-3.3			±0.1		±1.0	μΑ		
I _{CC}	Quiescent Supply	5.5			4.0		40.0	μА	$V_{IN} = V_{CC}$ or GND	
	Current	5.5			4.0		40.0	μΑ		
I _{CCT}	Maximum I _{CC} /Input	5.5			1.35		1.50	mA	V _{IN} = 3.4V	
		5.5			1.33		1.50	IIIA	Other Input = V _{CC} or GND	
I _{OFF}	Output Leakage Current	0.0			0.5		5.0	μА	V _{OUT} = 5.5V	
	(Power Down State)	0.0			0.5		5.0	μΛ		

Noise Characteristics

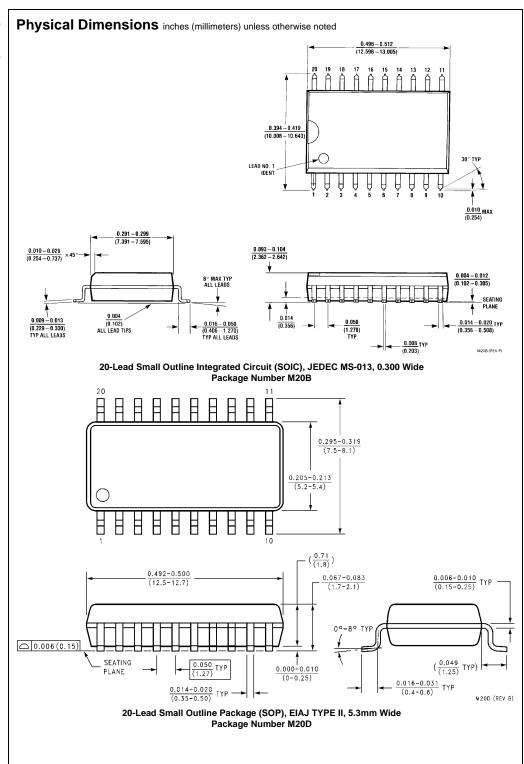
Symbol	Parameter	V _{CC}	T _A =	25°C	Units	Conditions	
0,	i aramoto	(V)	Тур	Limits	•	551141115115	
V _{OLP} (Note 7)	Quiet Output Maximum Dynamic V _{OL}	5.0	1.2	1.6	V	C _L = 50 pF	
V _{OLV} (Note 7)	Quiet Output Minimum Dynamic V _{OL}	5.0	-1.2	-1.6	V	C _L = 50 pF	
V _{IHD} (Note 7)	Minimum HIGH Level Dynamic Input Voltage	5.0		2.0	V	C _L = 50 pF	
V _{ILD} (Note 7)	Maximum LOW Level Dynamic Input Voltage	5.0		0.8	V	C _L = 50 pF	

Note 7: Parameter guaranteed by design.

AC Electrical Characteristics

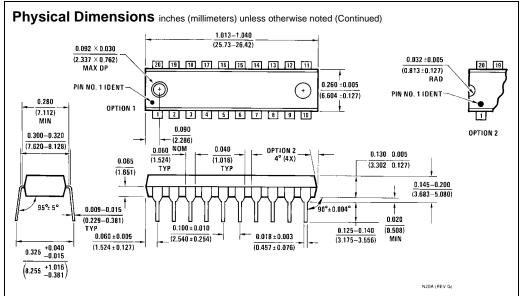
Symbol	Parameter	V _{CC}	T _A = 25°C		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions		
Cymbol		(V)	Min	Тур	Max	Min	Max	Onico	Conditions	
t _{PLH}	Propagation Delay	5.0 ± 0.5		4.9	7.7	1.0	8.5	ns		C _L = 15 pF
t _{PHL}	Time	3.0 ± 0.3		5.4	8.7	1.0	9.5	115		C _L = 50 pF
t _{PZL}	3-STATE Output	5.0 ± 0.5		9.4	13.8	1.0	15.0	20	$R_L = 1 k\Omega$	$C_L = 15 \text{ pF}$
t _{PZH}	Enable Time	5.0 ± 0.5		9.9	14.8	1.0	16.0	ns		$C_L = 50 \text{ pF}$
t _{PLZ}	3-STATE Output	5.0 ± 0.5		10.1	15.4	1.0	16.5	ns	$R_L = 1 k\Omega$	$C_L = 50 \text{ pF}$
t _{PHZ}	Disable Time	5.0 ± 0.5	10.1 15.4 1.0 16.5	115						
toslh	Output to	5.0 ± 0.5			1.0		1.0	ns	(Note 8)	
t _{OSHL}	Output Skew	5.0 ± 0.5			1.0		1.0	115		
C _{IN}	Input			4	10		10	pF	V _{CC} = Open	•
	Capacitance			4	10		10	þΓ		
C _{OUT}	Output			13				pF	$V_{CC} = 5.0V$	
	Capacitance			13				þΓ		
C _{PD}	C _{PD} Power Dissipation		40						(Note 9)	
	Capacitance		16					pF		

Note 8: Parameter guaranteed by design. $t_{OSLH} = |t_{PLH \; max} - t_{PLH \; min}|$: $t_{OSHL} = |t_{PHL \; max} - t_{PLH \; min}|$ Note 9: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC} (opr.) = $C_{PD} * V_{CC} * f_{|N} + I_{CC}/8$ (per F/F). The total C_{PD} when n pcs. of the Octal D Flip-Flop operates can be calculated by the equation: C_{PD} (total) = 20 + 12n.



Physical Dimensions inches (millimeters) unless otherwise noted (Continued) -0.20 4.16 64 4.4±0.1 -B-3,2 H0.42 ALL LEAD TIPS PIN #1 IDENT. -LAND PATTERN RECOMMENDATION SEE DETAIL A -0.90^{+0.15} 0.09-0.20 0.19-0.30 + 0.100 A B CS -12.00° R0.09min GAGE PLANE DIMENSIONS ARE IN MILLIMETERS NOTES: A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AC, REF NOTE 6, DATE 7/93. -0.6±0.1--R0.09mln B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS. DETAIL A D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N20A

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